



Product Summary

V _{RRM} (V)	I _O (A)	V _F Max (V) @ +25°C	I _R Max (mA) +25°C
60	2	0.51	0.15

Description and Applications

The SBR2U60S1F is a single rectifier packaged in SOD123F(Standard). Offering low V_F , low power loss and high efficiency, this device is ideal for use in general rectification applications as a:

- Boost Diode
- Blocking Diode

Features and Benefits

- Guard Ring Die Construction for Transient Protection
- Low Power Loss, High Efficiency
- Patented Interlocking Clip Design for High Surge Current Capacity
- Patented Super Barrier Rectifier SBR[®] Technology
- Qualified to AEC-Q101 Standards for High Reliability
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- An Automotive-Compliant Part is Available Under Separate Datasheet (<u>SBR2U60S1FQ</u>)

Mechanical Data

- Case: SOD123F (Standard)
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 ³
- Polarity: Cathode Band
- Weight: 0.015 grams (Approximate)

SOD123F (Standard)



Top View

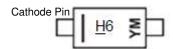
Ordering Information (Note 4)

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Part Number	Case	Packaging
SBR2U60S1F-7	SOD123F (Standard)	3,000/Tape & Reel

Notes: 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.

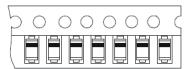
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

Marking Information



H6 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: F = 2018) M = Month (ex: 9 = September)

Bar Denotes Cathode Pin



Date Code Key

Year	2013	2014	2015	2016	2017	2018	2019	2020
Code	Α	В	С	D	Е	F	G	Н

Γ	Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
	Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load. For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _{RM}	60	V
Average Rectified Output Current	lo	2	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	35	Α

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Case (Note 5) Typical Thermal Resistance Junction to Ambient (Note 5)	R _{eJC} R _{eJA}	30 88	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +175	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	$V_{(BR)R}$	60		_	V	$I_R = 1.0 \text{mA}$
Forward Voltage Drop	V _F	_ _ _	0.37 0.44 0.42	0.46 0.51 —	V	I _F = 1A, T _J = +25°C I _F = 2A, T _J = +25°C I _F = 2A, T _J = +125°C
Leakage Current (Note 6)	I _R	_ _ _	20 50 6.5	 150 	μΑ μΑ mA	$V_R = 10V, T_J = +25$ °C $V_R = 60V, T_J = +25$ °C $V_R = 60V, T_J = +125$ °C
Total Capacitance	Ст	_	75	_	pF	V _R = 10V, f = 1MHz
Reverse Recovery Time	t _{RR}	_	11	_	ns	I _F = 0.5A, I _R = 1A, I _{RR} = 0.25A

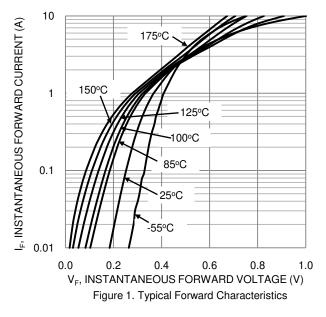
Notes:

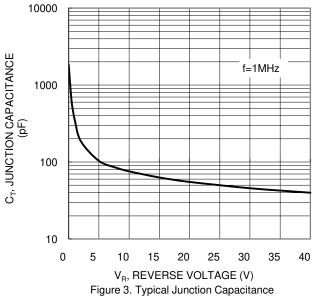
^{5.} Device mounted on FR-4 substrate, 1.0"*1.0", 2oz, single-sided, PC boards with 0.2"*0.25" copper pad.

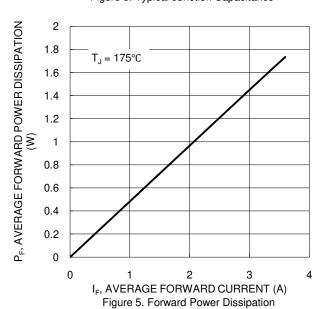
^{6.} Short duration pulse test used to minimize self-heating effect.

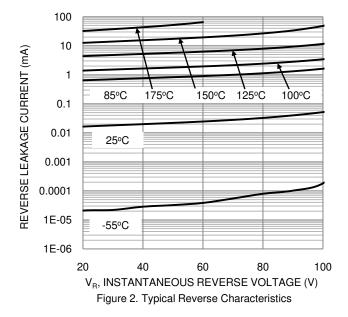


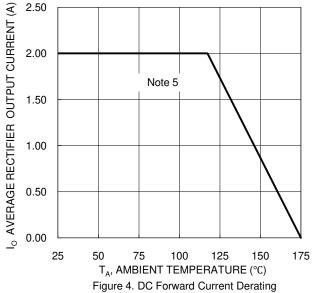










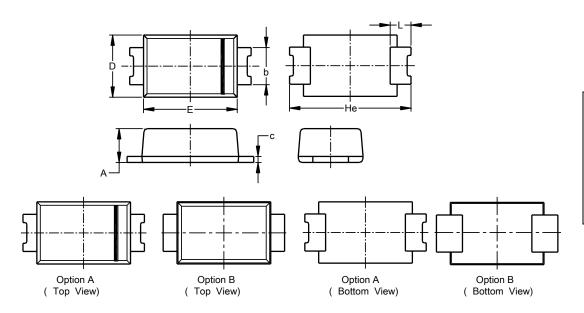




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOD123F (Standard)

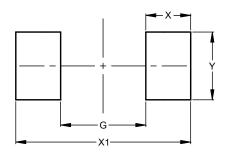


SOD123F (Standard)								
Dim	Min	Max	Тур					
Α	0.81	1.15	-					
b	0.80	1.35	-					
С	0.05	0.30	-					
D	1.70	1.90	1.80					
Е	2.60	2.80	2.70					
He	3.30	3.70	3.50					
J	0.35	0.85	1					
All [All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOD123F (Standard)



Dimensions	Value
Dilliciisions	(in mm)
G	1.90
Х	1.00
X1	3.90
Υ	1.50



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